

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: HENNHÖFER ET AL EXAMINER: R. KUNEMUND

SERIAL NO.: 09/032,305 GROUP: 1765

FILED: FEBRUARY 27, 1998

TITLE: PROCESS FOR TREATING A POLISHED SEMICONDUCTOR WAFER  
IMMEDIATELY AFTER THE SEMICONDUCTOR WAFER HAS BEEN  
POLISHED

PETITION UNDER RULE 136(a) AND RULE 17(a)(3)

ATTN: BOX CPA  
U.S. PATENT AND TRADEMARK OFFICE  
P.O. BOX 2327  
ARLINGTON, VA 22202

Dear Sir:

Applicants petition the Commissioner of Patents and Trademarks, under Rule 136(a), to extend the time for response to the Final Office Action dated August 7, 2001, for three months, from NOVEMBER 7, 2001 to FEBRUARY 7, 2002. Submitted herewith, under Rule 17(a)(3), is a check in the amount of \$920.00 to cover the cost of the extension for a Large Entity.

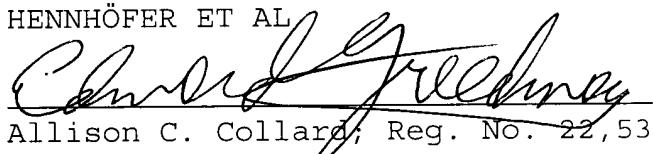
The Commissioner is hereby authorized to charge any additionally required fee, or to credit any overpayment, to our Deposit Account No. 03-2468.

02/07/2002 AWONDAF1 00000100 09032305

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920.00 0P

Respectfully submitted,  
HENNHÖFER ET AL

  
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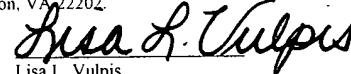
ERF/mt

Enclosure: Check in the amount of \$920.00.

EXPRESS MAIL NO. EL 871451739 US

Date of Deposit: February 4, 2002.

I hereby certify that this paper or fee is being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10, on the date indicated above, and is addressed to the U.S. Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202.

  
Lisa L. Vulpis